

# **Customer Information Notification**

Issue Date:13-Dec-2019Effective Date:14-Dec-2019

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# QUALITY

[] Test

[]Test

Packing/Shipping/Labeling Equipment

Process [] Test

Location

[] Design

[] Errata

[] Electrical

spec./Test coverage

# **Change Category**

[] Wafer Fab Process

[] Wafer Fab Materials

[] Wafer Fab Location

[] Firmware

LQFP64 High Density Leadframe Conversion in TFME

# [] Other

Process

Materials

Location

[] Assembly []

### Description

NXP Semiconductors announces the LQFP 10x10 64L lead frame conversion from standard matrix configuration to High Density configuration for the TongFu Microelectronics Co., Ltd. Nantong China assembled devices associated with this notification. No change to lead frame materials. There is a change on internal appearance with lead frame flag size has increased to 268 x 268 mils. No change on external appearance and case outline.

[X] Assembly [] Product Marking

Specification

[X] Assembly [] Mechanical

### Reason

LQFP 10x10 64L high density lead frame conversion is required for manufacturing standardization and capacity / utilization improvement.

# Identification of Affected Products

Product identification does not change

### Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality. **Disposition of Old Products** 

Existing inventory will be shipped until depleted

#### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

NXP Quality Management Team. About NXP Semiconductors

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Affected Part Numbers				
MCF51QU128VLH	MC56F84452VLH	MC56F84442VLH	MK22FN256VLH12	
MCF51JF128VLH	MK10DX32VLH5	MKV42F256VLH16	MK10DX128VLH7	
MC56F84763VLH	MK12DX256VLH5	MK20DX256VLH7	MKE16F256VLH16	
MK22FX512AVLH12	MK10DX256VLH7R	MK10DN128VLH5	MKE15Z256VLH7	
MKV46F256VLH16	MK10DX256VLH7	MK10DN64VLH5	MCF51JU128VLH	
MKE18F512VLH16	MK22FN512VLH12R	MK22FN1M0AVLH12	MK10DX64VLH7	
MKE14F512VLH16	MK22FN512VLH12	MKV46F128VLH16	MKM33Z128ACLH5R	
MKE14Z128VLH7	MKV42F128VLH16	MKS22FN128VLH12	MKM33Z128ACLH5	
MC9S08LL36CLH	MKS22FN256VLH12	MC9S08LC36LH	MKE16F512VLH16	
MC56F8257MLH	MCF51AG96CLH	MK20DN128VLH5	MKE14F256VLH16	
MC56F8257VLH	MK10DX128VLH5	MCF51QM128VLH	MWCT1013VLH	
MK22DX256VLH5	MK40DX256VLH7	MC56F84543VLH		
MC56F8247MLH	MK30DX64VLH7	MC9S08JM60CLH		
MKE14Z256VLH7	MK22DX128VLH5	MK20DX128VLH5		
MKE15Z128VLH7	MKV31F512VLH12	MK10DX64VLH5		
MKE18F256VLH16	MKV31F256VLH12	MK20DX128VLH7		